



# Product Change Notification

**Change Notification #:** 115722 - 00  
**Change Title:** Intel® Server Chassis H2312XXLR2, H2216XXLR2 and H2224XXLR2 PCN115722-00, Label, Power Supply Unit Label Change  
**Date of Publication:** August 07, 2017

**Key Characteristics of the Change:**  
 Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	August 22, 2017
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## Description of Change to the Customer:

The Intel® Server Chassis H2312XXLR2, H2216XXLR2 and H2224XXLR2 products listed in the “Products Affected/Intel Ordering Codes” table will undergo the following changes on the Power Supply label:

- Bureau of Indian Standards (BIS) mark added
- SoluM factory display name changed
- Part number from H66158-009 to H66158-010
- Revision from 03A to 04A

Please refer to the “Products Affected/Intel Ordering Codes” table below for a summary of TA changes.

## Current Power Supply Label:



## New Power Supply Label:

**intel SWITCHING POWER SUPPLY**  
 交換式電源供應器 컴퓨터용 전원공급장치  
 服务器内置电源 仅适用于海拔2000m以下地区安全使用  
 AUTORANGE INPUT(自動調整輸入/自動調整輸入): 47 - 63Hz

INPUT(輸入/輸入/정격입력): 100-127V~ 12A +12VSB --- 3.5A MAX  
 OUTPUT(輸出/輸出/정격출력): 1370W MAX +12V --- 89.5 - 110.5A MAX

INPUT(輸入/輸入/정격입력): 200-240V~ 10A +12VSB --- 3.5A MAX  
 OUTPUT(輸出/輸出/정격출력): 2130W MAX +12V --- 144.5 - 174.5A MAX

**WARNING**  
 Connect only to a properly earth grounded outlet.  
 Apparaten skall anslutas till jordat uttag.  
 Laite on liitettävä suojamaadoituskoskettimilla varustettuun pistorasiaan  
 插座必须正确接地

警告使用者: 此為電腦資訊技術設備, 於居住環境中使用時, 可能會造成射頻干擾, 在此種情況下, 使用者會被要求採取某些適當的對策。  
 聲明: 此為A級產品, 在生活環境中, 該產品可能會造成無線電干擾。在這種情況下, 可能要求用戶對其干擾採取切實可行的措施。  
 이 기기는 알 수 없음 (A급) 으로 전자파 방출 특성을 갖기 때문에, 가정외의 지역에서만 사용하는 것을 목적으로 합니다. A/S문의 : +82-2-767-2595

CE, CCC, ENEC, CUL, RoHS, R3A795, ZUJ0150-15002, MSIP-REI-SLU-PSSF222201A, R3A795, IS 13252 (Part 1) IEC 60950-1, R-41061310

For India Input: 200-240V~50/60Hz 16A  
 Other rating mentioned in the label is for other country

P/N: **H66158-010**  
 S/N: **CNS2221A4 JH6S0565**

MODEL (型號/型号/모델명): PSSF222201A REV(版本): **04A**  
 MADE IN CHINA (中國製造 / 中国製造 / 중국제조) 生产厂: 东莞索路研电子有限公司 DONGGUAN SOLUM ELECTRONICS CO., LTD.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2312XXLR2	942352	J17277-006	J17277-007
H2216XXLR2	942353	H95607-006	H95607-007
H2224XXLR2	943577	H96144-005	H96144-006

## PCN Revision History:

<b>Date of Revision:</b> August 07, 2017	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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